MOSFET – Power, Single, N-Channel 60 V, 61 A, 12 m Ω

Features

- Small Footprint (5x6 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- NVMFS5844NLWF Wettable Flanks Product
- NVMFS Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Parameter			Symbol	Value	Unit		
Drain-to-Source Voltage			V _{DSS}	60	V		
Gate-to-Source Voltage	Э		V _{GS}	±20	V		
Continuous Drain Cur- rent R _{ΨJ-mb} (Notes 1,		T _{mb} = 25°C	Ι _D	61	A		
2, 3, 4)	Steady State	T _{mb} = 100°C		43			
Power Dissipation		T _{mb} = 25°C	PD	107	W		
R _{ΨJ-mb} (Notes 1, 2, 3)		$T_{mb} = 100^{\circ}C$		54			
Continuous Drain Cur- rent R _{0.IA} (Notes 1, 3,		T _A = 25°C	Ι _D	11.2	А		
4)	Steady	T _A = 100°C		8.0	1		
Power Dissipation	State	T _A = 25°C	PD	3.7	W		
$R_{\theta JA}$ (Notes 1 & 3)		T _A = 100°C		1.8			
Pulsed Drain Current	T _A = 25	°C, t _p = 10 μs	I _{DM}	247	Α		
Current Limited by Package $T_A = 25^{\circ}C$ (Note 4)			I _{DmaxPkg}	80	A		
Operating Junction and Storage Temperature			T _J , T _{stg}	–55 to 175	°C		
Source Current (Body D	iode)		۱ _S	60	А		
Energy (T _J = 25°C, V _{DD}	Single Pulse Drain-to-Source Avalanche Energy (T _J = 25°C, V _{DD} = 50 V, V _{GS} = 10 V, $I_{L(pk)}$ = 31 A, L = 0.1 mH, R _G = 25 Ω)			48	mJ		
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C		

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Mounting Board (top) - Steady State (Notes 2, 3)	$R_{\Psi J-mb}$	1.4	°C/W
Junction-to-Ambient - Steady State (Note 3)	$R_{\theta JA}$	41	

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

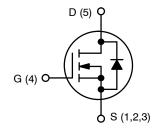
2. Psi (Ψ) is used as required per JESD51–12 for packages in which substantially less than 100% of the heat flows to single case surface.



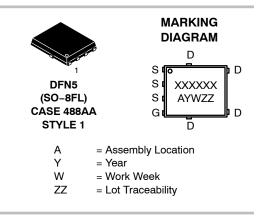
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V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
60 V	$12 \text{ m}\Omega @ 10 \text{ V}$	61 A
	16 m Ω @ 4.5 V	UIA



N-CHANNEL MOSFET



ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

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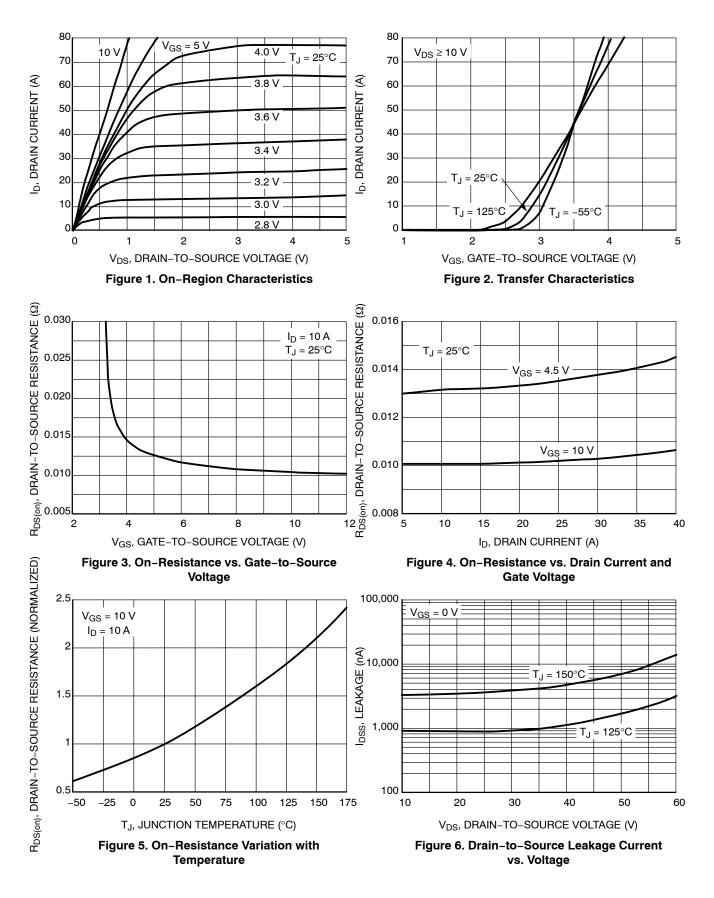
Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.
Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise specified)

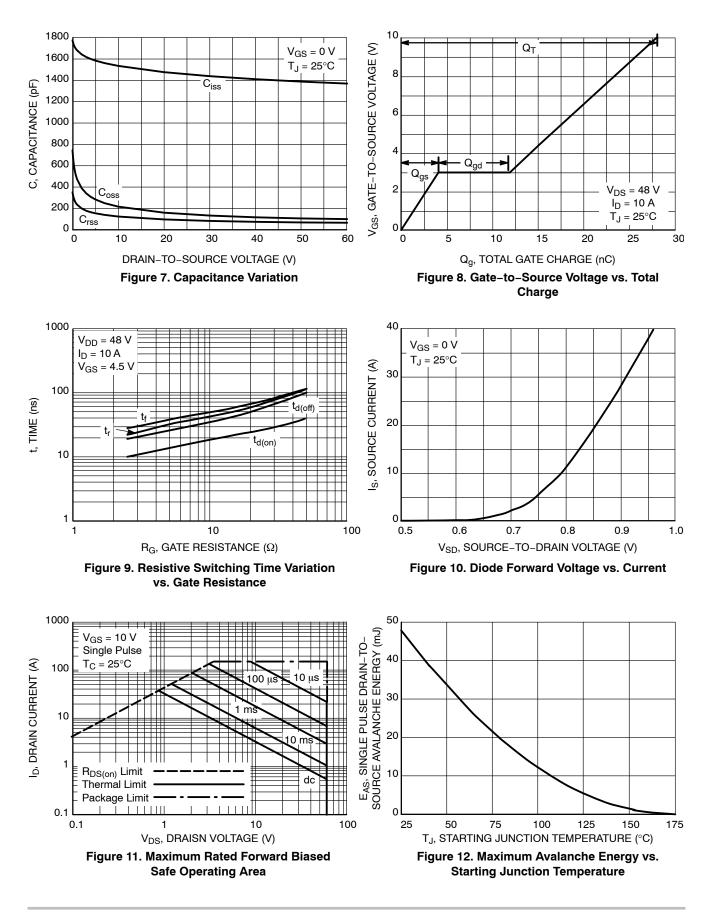
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit	
OFF CHARACTERISTICS								
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I _D = 250 μ A		60			V	
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J				57		mV/°C	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V,$	T _J = 25 °C			1		
		V _{DS} = 60 V	_S = 60 V T _J = 125°C			100	μΑ	
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS} = ±20 V				±100	nA	
ON CHARACTERISTICS (Note 5)				-				
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D$	= 250 μA	1.5		2.3	V	
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J				6.2		mV/°C	
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 10 A		10.2	12	-	
		V _{GS} = 4.5 V	I _D = 10 A		13	16	mΩ	
Forward Transconductance	9fs	V _{DS} = 5 V, I _D = 10 A			27		S	
CHARGES, CAPACITANCES & GATE RESIS	STANCE							
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 25 V			1460		pF	
Output Capacitance	C _{OSS}				150			
Reverse Transfer Capacitance	C _{RSS}				96			
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 10 V, V_{DS} = 48 V; I_{D} = 10 A			30		nC	
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 4.5 V, V _{DS} = 48 V; I _D = 10 A			15			
Threshold Gate Charge	Q _{G(TH)}				1.0			
Gate-to-Source Charge	Q _{GS}				4.0			
Gate-to-Drain Charge	Q _{GD}				8.0			
Plateau Voltage	V _{GP}				3.0		V	
Gate Resistance	R _G				0.62		Ω	
SWITCHING CHARACTERISTICS (Note 6)								
Turn-On Delay Time	t _{d(ON)}	V_{GS} = 4.5 V, V_{DS} = 48 V, I_D = 10 A, R_G = 2.5 Ω			12		ns	
Rise Time	t _r				25			
Turn-Off Delay Time	t _{d(OFF)}				20			
Fall Time	t _f				10			
DRAIN-SOURCE DIODE CHARACTERISTIC								
Forward Diode Voltage	V_{SD} $V_{GS} = 0 V$, $T_J = 25^{\circ}$		$T_J = 25^{\circ}C$		0.79	1.2		
		$I_{\rm S} = 10 \rm{A}$	T _J = 125°C		0.65		V	
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, dIS/dt = 100 A/µs, I _S = 10 A			19		ns	
Charge Time	t _a				13			
Discharge Time	t _b				6.0			
Reverse Recovery Charge	Q _{BB}				15		nC	

6. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



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TYPICAL CHARACTERISTICS

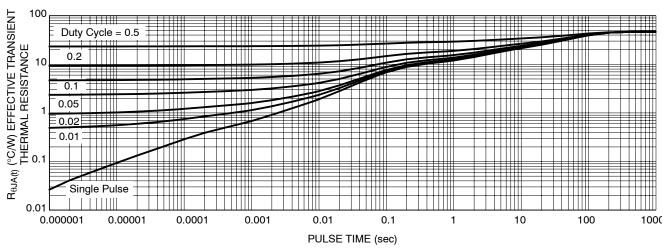


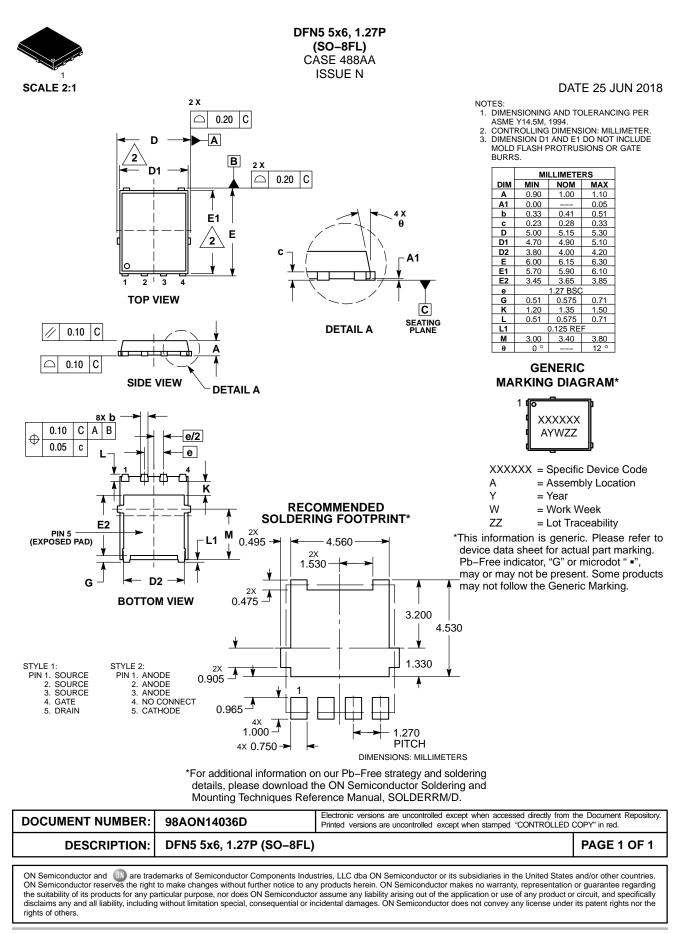
Figure 13. Thermal Response

Device	Marking	Package	Shipping [†]
NTMFS5844NLT1G	5844NL	DFN5 (Pb-Free)	1500 / Tape & Reel
NVMFS5844NLT1G	V5844L	DFN5 (Pb-Free)	1500 / Tape & Reel
NVMFS5844NLWFT1G	5844LW	DFN5 (Pb-Free)	1500 / Tape & Reel
NVMFS5844NLT3G	V5844L	DFN5 (Pb–Free)	5000 / Tape & Reel
NVMFS5844NLWFT3G	5844LW	DFN5 (Pb-Free)	5000 / Tape & Reel

DEVICE ORDERING INFORMATION

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.





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